

WST2005

P-Ch MOSFET

#### **General Description**

The H is P-Channel enhancement mode power MOSFET which is produced with high cell density and DMOS trench technology .This device particularly suits low voltage applications, especially for battery powered circuits, the tiny and thin outline saves PCB consumption. are electrically identical. -RoHS Compliant

### **Product Summery**

| BVDSS | RDSON | ID    |  |  |
|-------|-------|-------|--|--|
| -20V  | 155mΩ | -1.6A |  |  |

#### Applications

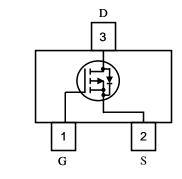
- High Frequency Point-of-Load Synchronous s Small power switching for MB/NB/UMPC/VGA
- A Switch and Battery Switch for Portable Devices
- Load Switch

## **SOT-323 Pin Configuration**

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available





#### Absolute Maximum Ratings

| Symbol                              | Parameter  | Rating     | Units |
|-------------------------------------|--|------------|-------|
| V <sub>DS</sub>                     | Drain-Source Voltage   | -20        | V     |
| V <sub>GS</sub>                     | Gate-Source Voltage  | ±12        | V     |
| I <sub>D</sub> @T <sub>c</sub> =25℃ | Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup> | -1.6       | A     |
| I <sub>DM</sub>                     | Pulsed Drain Current <sup>2</sup>                              | -5         | А     |
| P₀@T <sub>A</sub> =25℃              | Total Power Dissipation <sup>3</sup>                           | 350        | mW    |
| T <sub>STG</sub>                    | Storage Temperature Range -55 to 150                           |            | °C    |
| TJ                                  | Operating Junction Temperature Range                           | -55 to 150 | Ĉ     |



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## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

| Symbol              | Parameter                                      | Conditions  | Min. | Тур. | Max. | Unit |  |
|---------------------|--|---|------|------|------|------|--|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA  | -20  |      |      | V    |  |
|                     |  | V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-1A  |      | 145  | 155  |      |  |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-0.5A  |      | 150  | 168  | mΩ   |  |
|                     |  | V <sub>GS</sub> =-1.8V , I <sub>D</sub> =-0.3A  |      | 180  | 220  |      |  |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                         | $V_{GS}=V_{DS}$ , $I_D = -250 uA$   | -0.4 | -0.7 | -1   | V    |  |
| I <sub>DSS</sub>    | Drain-Source Leakage Current                   | $V_{\text{DS}}\text{=-20V}$ , $V_{\text{GS}}\text{=}0\text{V}$ , $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$ |      |      | -1   | uA   |  |
| I <sub>GSS</sub>    | Gate-Source Leakage Current                    | Gate-Source Leakage Current V <sub>GS</sub> =±12V , V <sub>DS</sub> =0V                                     |      |      | ±100 | nA   |  |
| gfs                 | Forward Transconductance                       | V <sub>DS</sub> =-5V , I <sub>D</sub> =-2A  |      | 5    |      | S    |  |
| Qg                  | Total Gate Charge (-4.5V)                      |   |      | 4.9  |      |      |  |
| Q <sub>gs</sub>     | Gate-Source Charge                             | V <sub>DS</sub> =-6V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-2.8A                                       |      | 0.62 |      | nC   |  |
| Q <sub>gd</sub>     | Gate-Drain Charge                              |   |      | 1.07 |      |      |  |
| T <sub>d(on)</sub>  | Turn-On Delay Time                             |   |      | 10.1 |      |      |  |
| Tr                  | Rise Time                                      | $V_{DS}$ =-6V , $V_{GS}$ =-4.5V ,   |      | 4.76 |      | ns   |  |
| T <sub>d(off)</sub> | Turn-Off Delay Time                            | $R_{GEN}=6\Omega$ , RL= $6\Omega$ ,   |      | 84.1 |      |      |  |
| T <sub>f</sub>      | Fall Time                                      |   |      | 25.2 |      |      |  |
| Ciss                | Input Capacitance                              |   |      | 472  |      |      |  |
| C <sub>oss</sub>    | Output Capacitance                             | V <sub>DS</sub> =-6V , V <sub>GS</sub> =0V , f=1MHz   |      | 71   |      | pF   |  |
| Crss                | Reverse Transfer Capacitance                   |   |      | 51   |      |      |  |

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

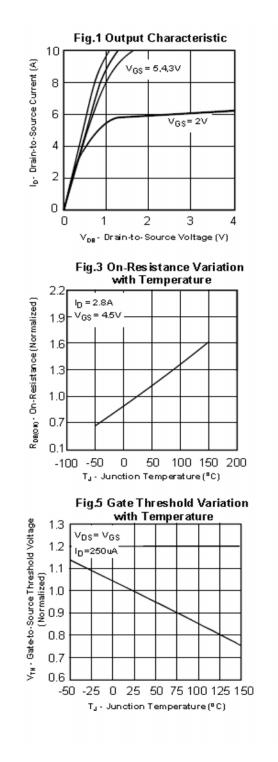
3.The power dissipation is limited by 150  $^\circ\!\mathrm{C}$  junction temperature

4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



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# **Typical Characteristics**



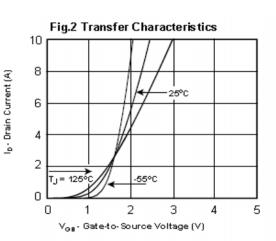
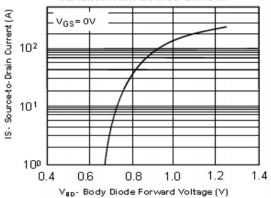
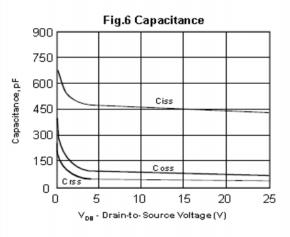


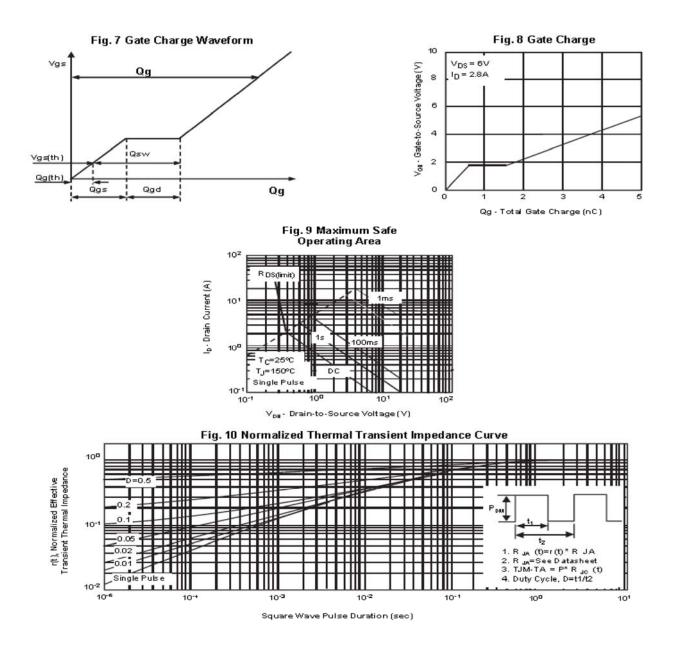
Fig.4 Body Diode Forward Voltage Variation with Source Current







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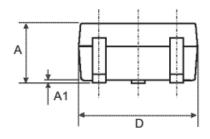


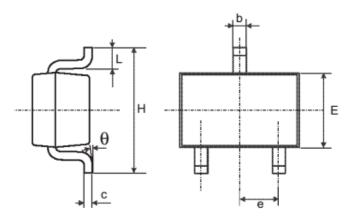


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# SOT-323 Package Outline Dimensions





|      | DIMENSIONS  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
| REF. | Millimeters |      |      | Inches |       |       |
|      | Min.        | Тур. | Max. | Min.   | Тур.  | Max.  |
| Α    | 0.8         |      | 1.1  | 0.031  |       | 0.043 |
| A1   | 0.0         |      | 0.1  | 0.0    |       | 0.004 |
| b    | 0.25        |      | 0.4  | 0.010  |       | 0.016 |
| с    | 0.1         |      | 0.26 | 0.004  |       | 0.010 |
| D    | 1.8         | 2.0  | 2.2  | 0.071  | 0.079 | 0.086 |
| Е    | 1.15        | 1.25 | 1.35 | 0.045  | 0.049 | 0.053 |
| е    |             | 0.65 |      |        | 0.026 |       |
| Н    | 1.8         | 2.1  | 2.4  | 0.071  | 0.083 | 0.094 |
| L    | 0.1         | 0.2  | 0.3  | 0.004  | 0.008 | 0.012 |
| θ    | 0           |      | 30°  | 0      |       | 30°   |



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